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DGD21904

### HIGH-SIDE AND LOW-SIDE GATE DRIVER IN SO-14 (Type TH)

### **Description**

The DGD21904 is a high voltage / high speed gate driver capable of driving N-Channel MOSFETs and IGBTs in a half bridge configuration. High voltage processing techniques enable the DGD21904's high-side to switch to 600V in a bootstrap operation under high dV/dt conditions.

The DGD21904 logic inputs are compatible with standard TTL and CMOS levels (down to 3.3V) for easy interfacing with controlling devices. The driver outputs feature high pulse current buffers designed for minimum driver cross conduction.

The DGD21904 is available in SO-14 (Type TH) package. The operating temperature extends from -40°C to +125°C.

### **Applications**

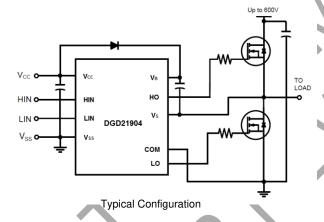
- DC-DC Converters
- DC-AC Inverters
- AC-DC Power Supplies
- Motor Controls
- Class D Power Amplifiers

### **Features**

- Floating High-side Driver in Bootstrap Operation to 600V
- Drives Two N-Channel MOSFETs or IGBTs in a Half Bridge Configuation
- Output Drivers Capable of 4.5A/4.5A Typ Sink/Source
- Logic Input (HIN and LIN) 3.3V Capability
- Schmitt Triggered Logic Inputs with Internal Pull Down
- Undervoltage Lockout for High and Low-side Drivers
- Extended Temperature Range: -40°C to +125°C
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony free. "Green" Device (Note 3)

#### **Mechanical Data**

- Case: SO-14 (Type TH)
- Case Material: Molded Plastic. "Green" Molding Compound.
   UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Terminals: Finish Matte Tin Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Weight: 0.142 grams (Approximate)





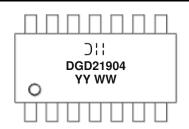
### Ordering Information (Note 4)

Part Number	Marking	Reel Size (inches)	Tape Width (mm)	Quantity Per Reel
DGD21904S14-13	DGD21904	13	16	2,500

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

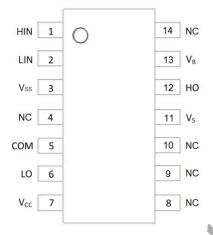
## **Marking Information**



OH = Manufacturer's Marking
DGD21904 = Product Type Marking Code
YY = Year (ex: 17 = 2017)
WW = Week (01 to 53)



### **Pin Diagrams**

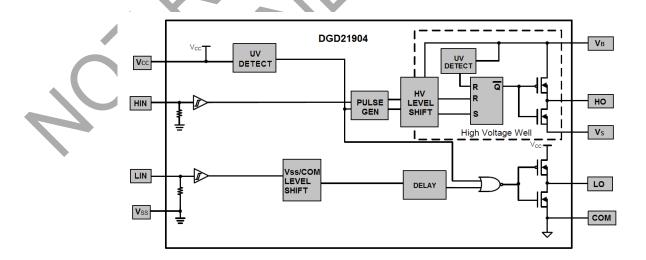


Top View: SO-14 (Type TH)

### **Pin Descriptions**

Pin Number	Pin Name	Function
1	HIN	Logic input for high-side gate driver output, in phase with HO
2	LIN	Logic input for low-side gate driver output, in phase with LO
3	$V_{SS}$	Logic ground
4, 8, 9, 10, 14	NC	No connection (No Internal Connection)
5	COM	Low-side and logic return
6	LO	Low-side gate drive output
7	$V_{CC}$	Low-side and logic fixed supply
11	Vs	High-side floating supply return
12	НО	High-side gate drive output
13	$V_{B}$	High-side floating supply

# **Functional Block Diagram**





**DGD21904** 

### **Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
High-side Floating Supply Voltage	V <sub>B</sub>	-0.3 to +624	V
High-side Floating Supply Offset Voltage	Vs	V <sub>B</sub> -24 to V <sub>B</sub> +0.3	V
Logic Supply Offset Voltage	V <sub>SS</sub>	V <sub>CC</sub> -24 to V <sub>CC</sub> +0.3	V
High-side Floating Output Voltage	$V_{HO}$	$V_S$ -0.3 to $V_B$ +0.3	V
Offset Supply Voltage Transient	dV <sub>S</sub> / dt	50	V/ns
Low-side and Logic Fixed Supply Voltage	V <sub>CC</sub>	-0.3 to +24	V
Low-side Output Voltage	$V_{LO}$	-0.3 to V <sub>CC</sub> +0.3	V
Logic Input Voltage (HIN and LIN)	V <sub>IN</sub>	-0.3 to V <sub>CC</sub> +0.3	V

### Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation Linear Derating Factor (Note 5)	P <sub>D</sub>	0.862	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	145	°C/W
Operating Temperature	TJ	+150	
Lead Temperature (Soldering, 10s)	TL	+300	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	

Note: 5. When mounted on a standard JEDEC 2-layer FR-4 board.

### **Recommended Operating Conditions**

Parameter	Symbol	Min	Max	Unit
High Side Floating Supply Absolute Voltage	V <sub>B</sub>	V <sub>S</sub> + 10	V <sub>S</sub> + 20	V
High Side Floating Supply offset voltage	Vs	(Note 6)	600	V
Logic Ground	V <sub>SS</sub>	-5	5	V
High Side Floating Output Voltage	V <sub>HO</sub>	Vs	V <sub>B</sub>	V
Low Side Fixed Supply Voltage	V <sub>CC</sub>	10	20	V
Low Side Output Voltage	$V_{LO}$	0	V <sub>CC</sub>	V
Logic Input Voltage (HIN and LIN)	V <sub>IN</sub>	0	5	V
Ambient Temperature	TA	-40	+125	°C

Note: 6. Logic operation for V<sub>S</sub> of -5V to +600V. Logic state held for V<sub>S</sub> of -5V to -V<sub>BS</sub>.



**DGD21904** 

# $\hline \textbf{DC Electrical Characteristics} \ (V_{BIAS} \ (V_{CC}, V_{BS}) = 15V, @T_A = +25^{\circ}C, \text{ unless otherwise specified.}) \ (Note \ 7)$

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Logic "1" Input Voltage	V <sub>IH</sub>	2.5	_		V	V <sub>CC</sub> = 10V to 20V
Logic "0" Input Voltage	$V_{IL}$	_	_	0.8	V	V <sub>CC</sub> = 10V to 20V
High Level Output Voltage, VBIAS - VO	$V_{OH}$	_	_	0.1	V	$I_O = 0mA$
Low Level Output Voltage, V <sub>O</sub>	$V_{OL}$	_	_	0.035	V	$I_O = 0mA$
Offset Supply Leakage Current	$I_{LK}$	_	_	50	μΑ	$V_B = V_S = 600V$
Quiescent V <sub>BS</sub> Supply Current	I <sub>BSQ</sub>	_	45	80	μΑ	$V_{IN} = 0V \text{ or } 5V$
Quiescent V <sub>CC</sub> Supply Current	I <sub>CCQ</sub>	_	75	200	μΑ	$V_{IN} = 0V \text{ or } 5V$
Logic "1" Input Bias Current	$I_{IN+}$	_	25	50	μΑ	$V_{IN} = 5V$
Logic "0" Input Bias Current	I <sub>IN-</sub>	_	1.0	2.0	μΑ	$V_{IN} = 0V$
V <sub>BS</sub> Supply Undervoltage Positive Going Threshold	$V_{BSUV}$	7.6	8.4	9.8	V	$\overline{}$
V <sub>BS</sub> Supply Undervoltage Negative Going Threshold	$V_{BSUV_{\text{-}}}$	6.9	7.8	9.0	V	_
V <sub>CC</sub> Supply Undervoltage Positive Going Threshold	$V_{CCUV+}$	7.6	8.4	9.8	V	_
V <sub>CC</sub> Supply Undervoltage Negative Going Threshold	V <sub>CCUV</sub> -	6.9	7.8	9.0	V	_
V <sub>CC</sub> and V <sub>BS</sub> Undervoltage Hysteresis	$V_{CCUVH}$	_	0.6	1	V	_
VCC and VBS Undervoitage Hysteresis	$V_{BSUVH}$	_	0.6		V	_
Output High Short Circuit Pulsed Current	I <sub>O+</sub>	3.5	4.5		Α	$V_O = 0V$ , PW $\leq 10$ ms
Output Low Short Circuit Pulsed Current	I <sub>O-</sub>	3.5	4.5		A	V <sub>O</sub> = 15V, PW ≤ 10ms

Note: 7. The V<sub>IN</sub> and I<sub>IN</sub> parameters are applicable to the two logic pins; HIN and LIN The V<sub>O</sub> and I<sub>O</sub> parameters are applicable to the respective output pins: HO and LO.

# AC Electrical Characteristics ( $V_{BIAS}$ ( $V_{CC}$ , $V_{BS}$ ) = 15V, $C_L$ = 1000pF, @ $T_A$ = +25°C, unless otherwise specified.)

Parameter	Symbol	Min	Тур	Max	Unit	Conditions
Turn-on Propagation Delay	ton	- <	140	200	ns	$V_S = 0V$
Turn-off Propagation Delay	t <sub>OFF</sub>	_	140	200	ns	$V_S = 0V$
Delay Matching, HO & LO Turn On/Off	t <sub>DM</sub>	-		50	ns	_
Turn-on Rise Time	t <sub>R</sub>		25	50	ns	$V_S = 0V$
Turn-off Fall Time	t <sub>F</sub>		20	45	ns	$V_S = 0V$



### **Timing Waveforms**

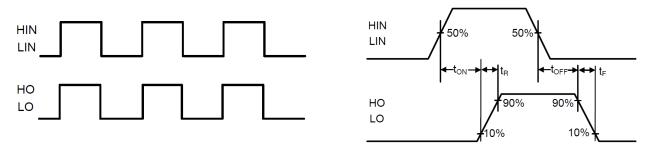


Figure 1. Input / Output Timing Diagram

Figure 2. Switching Time Waveform Definitions

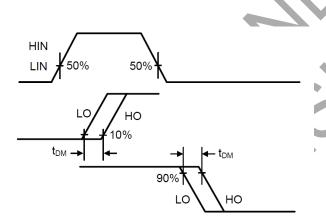


Figure 3. Delay Matching Waveform Definitions



### Typical Performance Characteristics (@TA = +25°C, unless otherwise specified.)

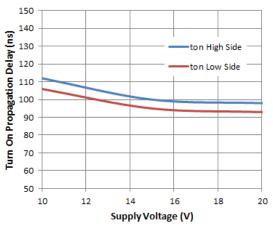


Figure 4. Turn-on Propagation Delay vs. Supply Voltage

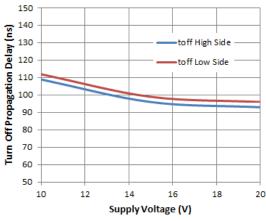


Figure 6. Turn-off Propagation Delay vs. Supply Voltage

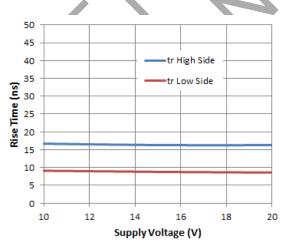


Figure 8. Rise Time vs. Supply Voltage

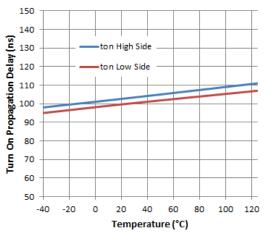


Figure 5. Turn-on Propagation Delay vs. Temperature

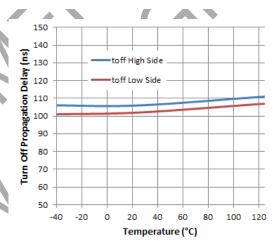


Figure 7. Turn-off Propagation Delay vs. Temperature

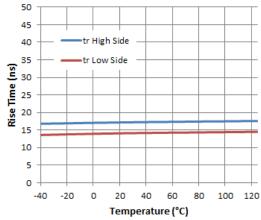


Figure 9. Rise Time vs. Temperature



# **Typical Performance Characteristics (Cont.)**

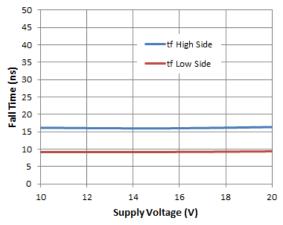


Figure 10. Fall Time vs. Supply Voltage

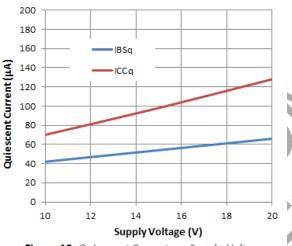


Figure 12. Quiescent Current vs. Supply Voltage

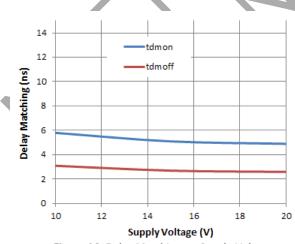


Figure 14. Delay Matching vs. Supply Voltage

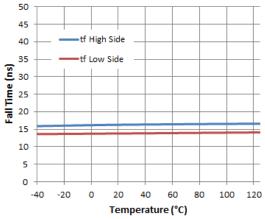


Figure 11. Fall Time vs. Temperature

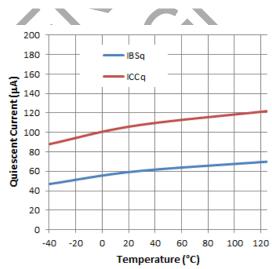


Figure 13. Quiescent Current vs. Temperature

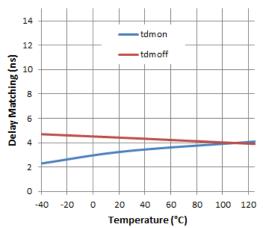


Figure 15. Delay Matching vs. Temperature



## **Typical Performance Characteristics (Cont.)**

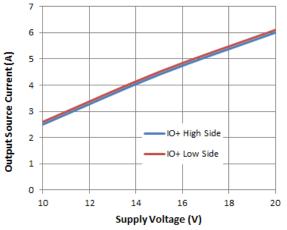


Figure 16. Output Source Current vs. Supply Voltage

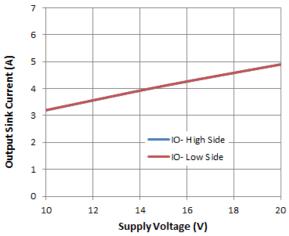


Figure 18. Output Sink Current vs. Supply Voltage

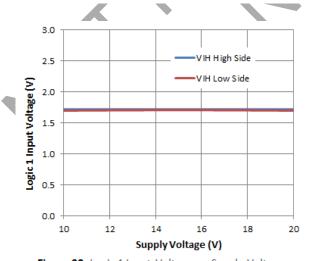


Figure 20. Logic 1 Input Voltage vs. Supply Voltage

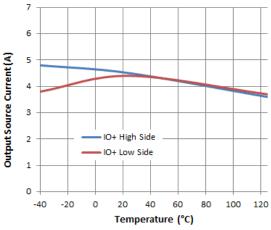


Figure 17. Output Source Current vs. Temperature

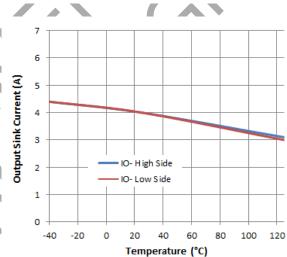


Figure 19. Output Sink Current vs. Temperature

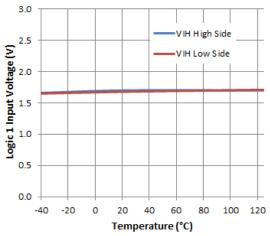


Figure 21. Logic 1 Input Voltage vs. Temperature



## **Typical Performance Characteristics** (Cont.)

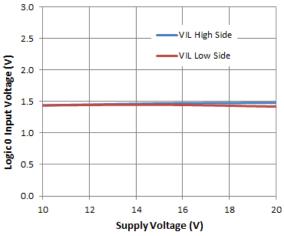


Figure 22. Logic O Input Voltage vs. Supply Voltage

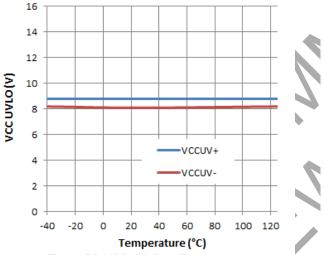


Figure 24. VCC UVLO vs. Temperature

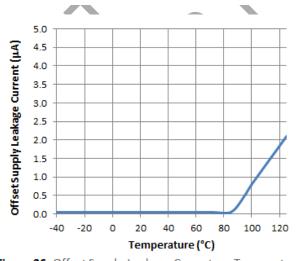


Figure 26. Offset Supply Leakage Current vs. Temperature

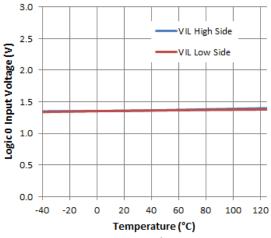


Figure 23. Logic 0 Input Voltage vs. Temperature

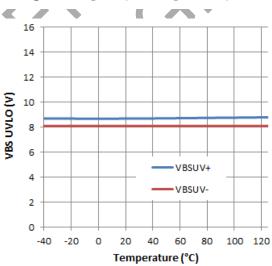


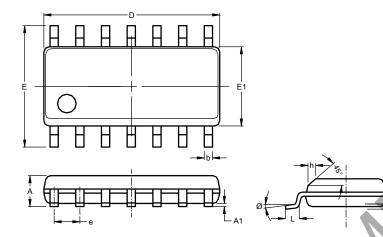
Figure 25. VBS UVLO vs. Temperature

**DGD21904** 

### **Package Outline Dimensions**

Please see http://www.diodes.com/package-outlines.html for the latest version.

### SO-14 (Type TH)

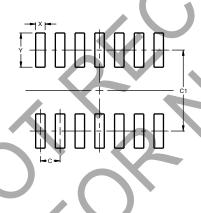


SO-14 (Type TH)					
Dim	Min	Max	Тур		
Α	1.55	1.73			
<b>A</b> 1	0.10	0.25			
b	0.35	0.51			
С	0.190	0.248			
D	8.56	8.74	8.61		
Е	5.84	6.20	6.00		
E1	3.81	3.99	3.94		
е			1.27		
h	1	i	0.33		
_	0.41	0.89			
Ø	0°	8°			
All Dimensions in mm					

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.

SO-14 (Type TH)



Dimensions	Value (in mm)
С	1.27
C1	5.20
Х	0.60
V	2 20

Note: For high voltage applications, the appropriate industry sector guidelines should be considered with regards to creepage and clearance distances between device Terminals and PCB tracking.



**DGD21904** 

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